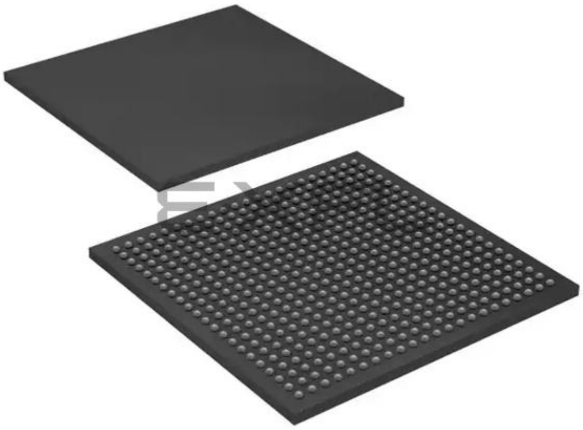
Intel - EP4CE30F23I8LN Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details	
Product Status	Active
Number of LABs/CLBs	1803
Number of Logic Elements/Cells	28848
Total RAM Bits	608256
Number of I/O	328
Number of Gates	-
Voltage - Supply	0.97V ~ 1.03V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BGA
Supplier Device Package	484-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep4ce30f23i8ln

For more information, refer to the *External Memory Interfaces in Cyclone IV Devices* chapter.

Configuration

Cyclone IV devices use SRAM cells to store configuration data. Configuration data is downloaded to the Cyclone IV device each time the device powers up. Low-cost configuration options include the Altera EPCS family serial flash devices and commodity parallel flash configuration options. These options provide the flexibility for general-purpose applications and the ability to meet specific configuration and wake-up time requirements of the applications.

Table 1–9 lists which configuration schemes are supported by Cyclone IV devices.

Table 1–9. Configuration Schemes for Cyclone IV Device Family

Devices	Supported Configuration Scheme
Cyclone IV GX	AS, PS, JTAG, and FPP *(1)*
Cyclone IV E	AS, AP, PS, FPP, and JTAG

Note to Table 1–9:

(1) The FPP configuration scheme is only supported by the EP4CGX30F484 and EP4CGX50/75/110/150 devices.

IEEE 1149.6 (AC JTAG) is supported on all transceiver I/O pins. All other pins support IEEE 1149.1 (JTAG) for boundary scan testing.

For more information, refer to the *JTAG Boundary-Scan Testing for Cyclone IV Devices* chapter.

For Cyclone IV GX devices to meet the PCIe 100 ms wake-up time requirement, you must use passive serial (PS) configuration mode for the EP4CGX15/22/30 devices and use fast passive parallel (FPP) configuration mode for the EP4CGX30F484 and EP4CGX50/75/110/150 devices.

For more information, refer to the *Configuration and Remote System Upgrades in Cyclone IV Devices* chapter.

The cyclical redundancy check (CRC) error detection feature during user mode is supported in all Cyclone IV GX devices. For Cyclone IV E devices, this feature is only supported for the devices with the core voltage of 1.2 V.

For more information about CRC error detection, refer to the *SEU Mitigation in Cyclone IV Devices* chapter.

High-Speed Transceivers (Cyclone IV GX Devices Only)

Cyclone IV GX devices contain up to eight full duplex high-speed transceivers that can operate independently. These blocks support multiple industry-standard communication protocols, as well as Basic mode, which you can use to implement your own proprietary protocols. Each transceiver channel has its own pre-emphasis and equalization circuitry, which you can set at compile time to optimize signal integrity and reduce bit error rates. Transceiver blocks also support dynamic reconfiguration, allowing you to change data rates and protocols on-the-fly.

Logic Array Blocks

Logic array blocks (LABs) contain groups of LEs.

Topology

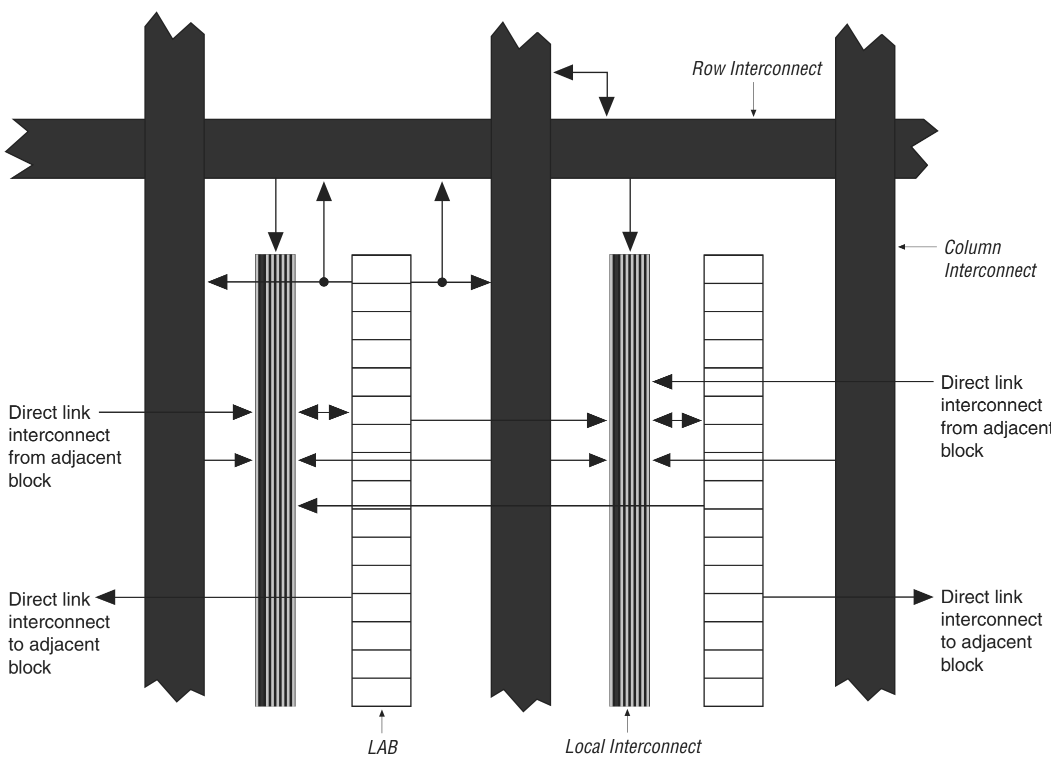
Each LAB consists of the following features:

- 16 LEs
- LAB control signals
- LE carry chains
- Register chains
- Local interconnect

The local interconnect transfers signals between LEs in the same LAB. Register chain connections transfer the output of one LE register to the adjacent LE register in an LAB. The Quartus II Compiler places associated logic in an LAB or adjacent LABs, allowing the use of local and register chain connections for performance and area efficiency.

Figure 2–4 shows the LAB structure for Cyclone IV devices.

Figure 2–4. Cyclone IV Device LAB Structure



4. Embedded Multipliers in Cyclone IV Devices

CYIV-51004-1.1

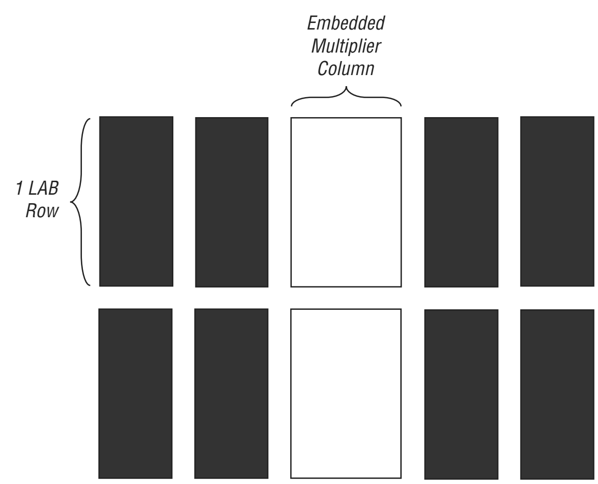
Cyclone® IV devices include a combination of on-chip resources and external interfaces that help increase performance, reduce system cost, and lower the power consumption of digital signal processing (DSP) systems. Cyclone IV devices, either alone or as DSP device co-processors, are used to improve price-to-performance ratios of DSP systems. Particular focus is placed on optimizing Cyclone IV devices for applications that benefit from an abundance of parallel processing resources, which include video and image processing, intermediate frequency (IF) modems used in wireless communications systems, and multi-channel communications and video systems.

This chapter contains the following sections:

Embedded Multiplier Block Overview

Figure 4–1 shows one of the embedded multiplier columns with the surrounding logic array blocks (LABs). The embedded multiplier is configured as either one 18 × 18 multiplier or two 9 × 9 multipliers. For multiplications greater than 18 × 18, the Quartus® II software cascades multiple embedded multiplier blocks together. There are no restrictions on the data width of the multiplier, but the greater the data width, the slower the multiplication process.

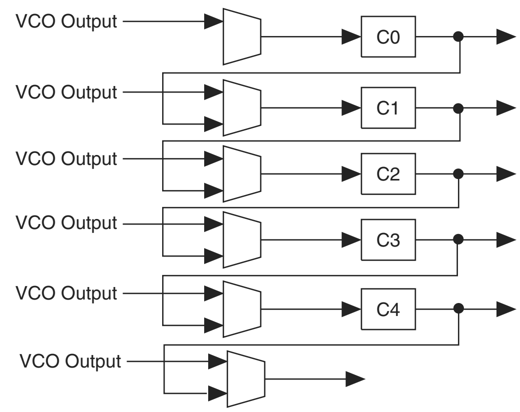
Figure 4–1. Embedded Multipliers Arranged in Columns with Adjacent LABs



Post-Scale Counter Cascading

PLLs of Cyclone IV devices support post-scale counter cascading to create counters larger than 512. This is implemented by feeding the output of one C counter into the input of the next C counter, as shown in Figure 5–16.

Figure 5–16. Counter Cascading



When cascading counters to implement a larger division of the high-frequency VCO clock, the cascaded counters behave as one counter with the product of the individual counter settings.

For example, if C0 = 4 and C1 = 2, the cascaded value is C0 × C1 = 8.

☞ Post-scale counter cascading is automatically set by the Quartus II software in the configuration file. Post-scale counter cascading cannot be performed using the PLL reconfiguration.

Programmable Duty Cycle

The programmable duty cycle allows PLLs to generate clock outputs with a variable duty cycle. This feature is supported on the PLL post-scale counters. You can achieve the duty cycle setting by a low and high time count setting for the post-scale counters. The Quartus II software uses the frequency input and the required multiply or divide rate to determine the duty cycle choices. The post-scale counter value determines the precision of the duty cycle. The precision is defined by 50% divided by the post-scale counter value. For example, if the C0 counter is 10, steps of 5% are possible for duty cycle choices between 5 to 90%.

Combining the programmable duty cycle with programmable phase shift allows the generation of precise non-overlapping clocks.

PLL Control Signals

You can use the `pfdena`, `areset`, and `locked` signals to observe and control the PLL operation and resynchronization.

For more information about the PLL control signals, refer to the *ALTPLL Megafunction User Guide*.

Designing with LVDS

Cyclone IV I/O banks support the LVDS I/O standard. The Cyclone IV GX right I/O banks support true LVDS transmitters while the Cyclone IV E left and right I/O banks support true LVDS transmitters. On the top and bottom I/O banks, the emulated LVDS transmitters are supported using two single-ended output buffers with external resistors. One of the single-ended output buffers is programmed to have opposite polarity. The LVDS receiver requires an external 100-Ω termination resistor between the two signals at the input buffer.

Figure 6–12 shows a point-to-point LVDS interface using Cyclone IV devices true LVDS output and input buffers.

Figure 6–12. Cyclone IV Devices LVDS Interface with True Output Buffer on the Right I/O Banks

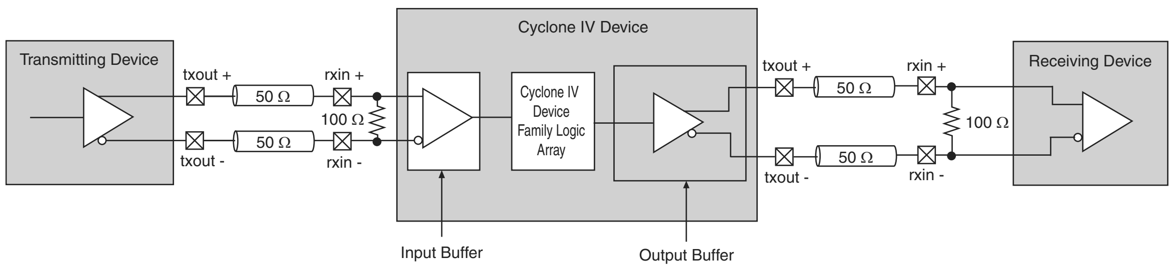
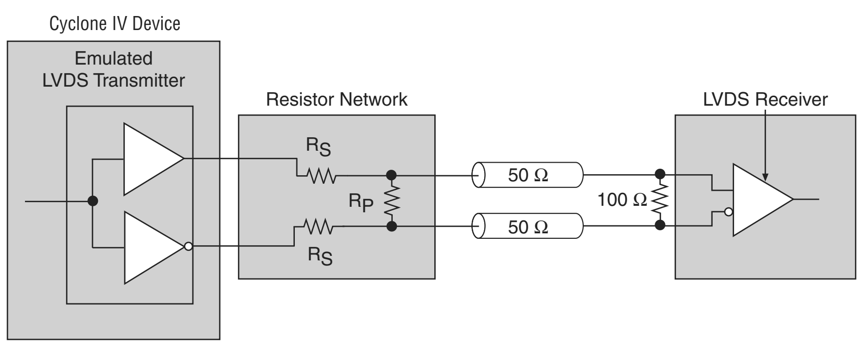


Figure 6–13 shows a point-to-point LVDS interface with Cyclone IV devices LVDS using two single-ended output buffers and external resistors.

Figure 6–13. LVDS Interface with External Resistor Network on the Top and Bottom I/O Banks *(1)*



Note to Figure 6–13:

(1) R_S = 120 Ω. R_P = 170 Ω.

BLVDS I/O Standard Support in Cyclone IV Devices

The BLVDS I/O standard is a high-speed differential data transmission technology that extends the benefits of standard point-to-point LVDS to multipoint configuration that supports bidirectional half-duplex communication. BLVDS differs from standard LVDS by providing a higher drive to achieve similar signal swings at the receiver while loaded with two terminations at both ends of the bus.

LVPECL I/O Support in Cyclone IV Devices

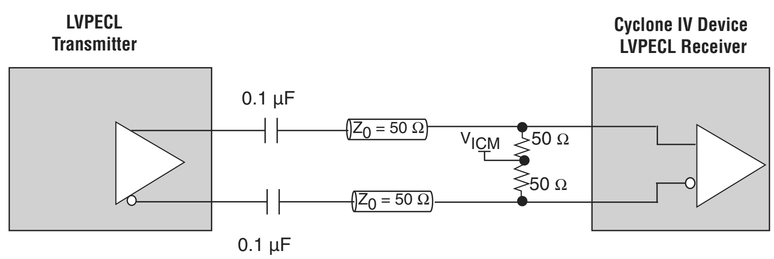
The LVPECL I/O standard is a differential interface standard that requires a 2.5-V V_{CCIO}. This standard is used in applications involving video graphics, telecommunications, data communications, and clock distribution. Cyclone IV devices support the LVPECL input standard at the dedicated clock input pins only. The LVPECL receiver requires an external 100-Ω termination resistor between the two signals at the input buffer.

For the LVPECL I/O standard electrical specification, refer to the *Cyclone IV Device Datasheet* chapter.

AC coupling is required when the LVPECL common mode voltage of the output buffer is higher than the Cyclone IV devices LVPECL input common mode voltage.

Figure 6–18 shows the AC-coupled termination scheme. The 50-Ω resistors used at the receiver are external to the device. DC-coupled LVPECL is supported if the LVPECL output common mode voltage is in the Cyclone IV devices LVPECL input buffer specification (refer to Figure 6–19).

Figure 6–18. LVPECL AC-Coupled Termination *(1)*

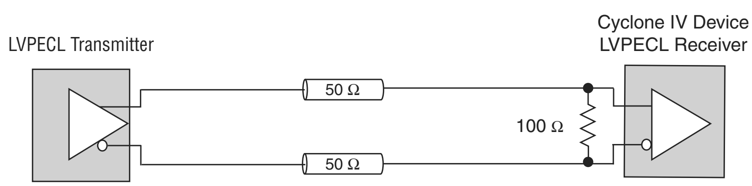


Note to Figure 6–18:

(1) The LVPECL AC-coupled termination is applicable only when an Altera FPGA transmitter is used.

Figure 6–19 shows the LVPECL DC-coupled termination.

Figure 6–19. LVPECL DC-Coupled Termination *(1)*



Note to Figure 6–19:

(1) The LVPECL DC-coupled termination is applicable only when an Altera FPGA transmitter is used.

During device configuration, Cyclone IV E devices read configuration data using the parallel interface and configure their SRAM cells. This scheme is referred to as the AP configuration scheme because the device controls the configuration interface. This scheme contrasts with the FPP configuration scheme, where an external host controls the interface.

AP Configuration Supported Flash Memories

The AP configuration controller in Cyclone IV E devices is designed to interface with two industry-standard flash families—the Micron P30 Parallel NOR flash family and the Micron P33 Parallel NOR flash family. Unlike serial configuration devices, both of the flash families supported in AP configuration scheme are designed to interface with microprocessors. By configuring from an industry standard microprocessor flash which allows access to the flash after entering user mode, the AP configuration scheme allows you to combine configuration data and user data (microprocessor boot code) on the same flash memory.

The Micron P30 flash family and the P33 flash family support a continuous synchronous burst read mode at 40 MHz `DCLK` frequency for reading data from the flash. Additionally, the Micron P30 and P33 flash families have identical pin-out and adopt similar protocols for data access.

☞ Cyclone IV E devices use a 40-MHz oscillator for the AP configuration scheme. The oscillator is the same oscillator used in the Cyclone IV E AS configuration scheme.

Table 8–10 lists the supported families of the commodity parallel flash for the AP configuration scheme.

Table 8–10. Supported Commodity Flash for AP Configuration Scheme for Cyclone IV E Devices (1)

Flash Memory Density	Micron P30 Flash Family (2)	Micron P33 Flash Family (3)
64 Mbit	✓	✓
128 Mbit	✓	✓
256 Mbit	✓	✓

Notes to Table 8–10:

(1) The AP configuration scheme only supports flash memory speed grades of 40 MHz and above.

(2) 3.3- , 3.0-, 2.5-, and 1.8-V I/O options are supported for the Micron P30 flash family.

(3) 3.3-, 3.0- and 2.5-V I/O options are supported for the Micron P33 flash family.

Configuring Cyclone IV E devices from the Micron P30 and P33 family 512-Mbit flash memory is possible, but you must properly drive the extra address and `FLASH_nCE` pins as required by these flash memories.

To check for supported speed grades and package options, refer to the respective flash datasheets.

The AP configuration scheme in Cyclone IV E devices supports flash speed grades of 40 MHz and above. However, AP configuration for all these speed grades must be capped at 40 MHz. The advantage of faster speed grades is realized when your design in the Cyclone IV E devices accesses flash memory in user mode.

For more information about the operation of the Micron P30 Parallel NOR and P33 Parallel NOR flash memories, search for the keyword "P30" or "P33" on the Micron website (www.micron.com) to obtain the P30 or P33 family datasheet.

Single-Device AP Configuration

The following groups of interface pins are supported in Micron P30 and P33 flash memories:

- Control pins
- Address pins
- Data pins

The following control signals are from the supported parallel flash memories:

- `CLK`
- active-low reset (`RST#`)
- active-low chip enable (`CE#`)
- active-low output enable (`OE#`)
- active-low address valid (`ADV#`)
- active-low write enable (`WE#`)

The supported parallel flash memories output a control signal (`WAIT`) to Cyclone IV E devices to indicate when synchronous data is ready on the data bus. Cyclone IV E devices have a 24-bit address bus connecting to the address bus (`A[24:1]`) of the flash memory. A 16-bit bidirectional data bus (`DATA[15..0]`) provides data transfer between the Cyclone IV E device and the flash memory.

The following control signals are from the Cyclone IV E device to flash memory:

- `DCLK`
- active-low hard rest (`nRESET`)
- active-low chip enable (`FLASH_nCE`)
- active-low output enable for the `DATA[15..0]` bus and `WAIT` pin (`nOE`)
- active-low address valid signal and is used to write data into the flash (`nAVD`)
- active-low write enable and is used to write data into the flash (`nWE`)

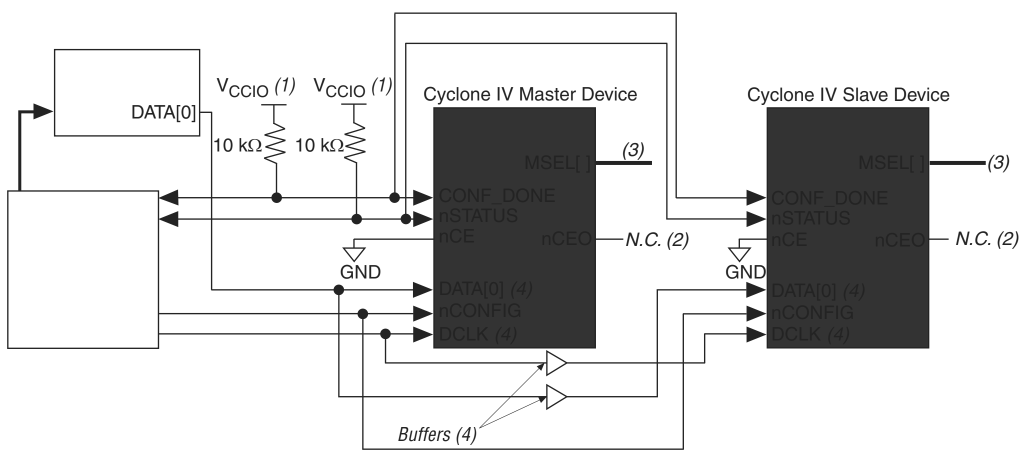
After the first device completes configuration in a multi-device configuration chain, its nCEO pin drives low to activate the nCE pin of the second device, which prompts the second device to begin configuration. The second device in the chain begins configuration in one clock cycle. Therefore, the transfer of data destinations is transparent to the external host device. nCONFIG, nSTATUS, DCLK, DATA[0], and CONF_DONE configuration pins are connected to every device in the chain. To ensure signal integrity and prevent clock skew problems, configuration signals may require buffering. Ensure that DCLK and DATA lines are buffered. All devices initialize and enter user mode at the same time because all CONF_DONE pins are tied together.

If any device detects an error, configuration stops for the entire chain and you must reconfigure the entire chain because all nSTATUS and CONF_DONE pins are tied together. For example, if the first device flags an error on nSTATUS, it resets the chain by pulling its nSTATUS pin low. This behavior is similar to a single device detecting an error.

You can have multiple devices that contain the same configuration data in your system. To support this configuration scheme, all device nCE inputs are tied to GND, while the nCEO pins are left floating. nCONFIG, nSTATUS, DCLK, DATA[0], and CONF_DONE configuration pins are connected to every device in the chain. To ensure signal integrity and prevent clock skew problems, configuration signals may require buffering. Ensure that the DCLK and DATA lines are buffered. Devices must be of the same density and package. All devices start and complete configuration at the same time.

Figure 8–15 shows a multi-device PS configuration when both Cyclone IV devices are receiving the same data.

Figure 8–15. Multi-Device PS Configuration When Both Devices Receive the Same Data



Notes to Figure 8–15:

(1) You must connect the pull-up resistor to a supply that provides an acceptable input signal for all devices in the chain. V_{CC} must be high enough to meet the V_{IH} specification of the I/O on the device and the external host.

(2) The nCEO pins of both devices are left unconnected or used as user I/O pins when configuring the same configuration data into multiple devices.

(3) The MSEL pin settings vary for different configuration voltage standards and POR time. To connect the MSEL pins, refer to Table 8–3 on page 8–8, Table 8–4 on page 8–8, and Table 8–5 on page 8–9. Connect the MSEL pins directly to V_{CCA} or GND.

(4) All I/O inputs must maintain a maximum AC voltage of 4.1 V. DATA[0] and DCLK must fit the maximum overshoot outlined in Equation 8–1 on page 8–5.

Table 8–28. Document Revision History (Part 2 of 2)

Date	Version	Changes
July 2010	1.2	Updated for the Quartus II software 10.0 release: ■ Updated “Power-On Reset (POR) Circuit”, “Configuration and JTAG Pin I/O Requirements”, and “Reset” sections. ■ Updated Figure 8–10. ■ Updated Table 8–16 and Table 8–17.
February 2010	1.1	Updated for the Quartus II software 9.1 SP1 release: ■ Added “Overriding the Internal Oscillator” and “AP Configuration (Supported Flash Memories)” sections. ■ Updated “JTAG Instructions” section. ■ Added Table 8–6. ■ Updated Table 8–2, Table 8–3, Table 8–4, Table 8–6, Table 8–11, Table 8–13, Table 8–14, Table 8–15, and Table 8–18. ■ Updated Figure 8–4, Figure 8–5, Figure 8–6, Figure 8–13, Figure 8–14, Figure 8–15, Figure 8–17, Figure 8–18, Figure 8–23, Figure 8–24, Figure 8–25, Figure 8–26, Figure 8–27, Figure 8–28, and Figure 8–29.
November 2009	1.0	Initial release.

Configuration error detection determines if the configuration data received through an external memory device is corrupted during configuration. To validate the configuration data, the Quartus® II software uses a function to calculate the CRC value for each configuration data frame and stores the frame-based CRC value in the configuration data as part of the configuration bit stream.

During configuration, Cyclone IV devices use the same methodology to calculate the CRC value based on the frame of data that is received and compares it against the frame CRC value in the data stream. Configuration continues until either the device detects an error or all the values are calculated.

In addition to the frame-based CRC value, the Quartus II software generates a 32-bit CRC value for the whole configuration bit stream. This 32-bit CRC value is stored in the 32-bit storage register at the end of the configuration and is used for user mode error detection that is discussed in "User Mode Error Detection".

User Mode Error Detection

☞ User mode error detection is available in Cyclone IV GX and Cyclone IV E devices with 1.2-V core voltage. Cyclone IV E devices with 1.0-V core voltage do not support user mode error detection.

Soft errors are changes in a configuration random-access memory (CRAM) bit state due to an ionizing particle. Cyclone IV devices have built-in error detection circuitry to detect data corruption by soft errors in the CRAM cells.

This error detection capability continuously computes the CRC of the configured CRAM bits based on the contents of the device and compares it with the pre-calculated CRC value obtained at the end of the configuration. If the CRCs match, there is no error in the current configuration CRAM bits. The process of error detection continues until the device is reset (by setting `nCONFIG` to low).

The Cyclone IV device error detection feature does not check memory blocks and I/O buffers. These device memory blocks support parity bits that are used to check the contents of memory blocks for any error. The I/O buffers are not verified during error detection because the configuration data uses flip-flops as storage elements that are more resistant to soft errors. Similar flip-flops are used to store the pre-calculated CRC and other error detection circuitry option bits.

The error detection circuitry in Cyclone IV devices uses a 32-bit CRC IEEE 802 standard and a 32-bit polynomial as the CRC generator. Therefore, a single 32-bit CRC calculation is performed by the device. If a soft error does not occur, the resulting 32-bit signature value is `0x00000000`, that results in a `0` on the `CRC_ERROR` output signal. If a soft error occurs in the device, the resulting signature value is non-zero and the `CRC_ERROR` output signal is `1`.

You can inject a soft error by changing the 32-bit CRC storage register in the CRC circuitry. After verifying the induced failure, you can restore the 32-bit CRC value to the correct CRC value with the same instruction and inserting the correct value.

☞ Before updating it with a known bad value, Altera recommends reading out the correct value.

For Transmitter and Receiver operation in bonded channel configuration, the receiver PCS supports configuration with rate match FIFO, and configuration without rate match FIFO. Figure 1–39 shows the datapath clocking in Transmitter and Receiver operation with rate match FIFO in ×2 and ×4 bonded channel configurations. For Transmitter and Receiver operation in bonded channel configuration without rate match FIFO, the datapath clocking is identical to Figure 1–38 for the bonded transmitter channels, and Figure 1–34 on page 1–35 for the receiver channels.

PIPE Interface

The PIPE interface provides a standard interface between the PCIe-compliant PHY and MAC layer as defined by the version 2.00 of the PIPE Architecture specification for Gen1 (2.5 Gbps) signaling rate. Any core or IP implementing the PHY MAC, data link, and transaction layers that supports PIPE 2.00 can be connected to the Cyclone IV GX transceiver configured in PIPE mode. Table 1–15 lists the PIPE-specific ports available from the Cyclone IV GX transceiver configured in PIPE mode and the corresponding port names in the PIPE 2.00 specification.

Table 1–15. Transceiver-FPGA Fabric Interface Ports in PIPE Mode

Transceiver Port Name	PIPE 2.00 Port Name
`tx_datain[15..0]` *(1)*	`TxData[15..0]`
`tx_ctrlenable[1..0]` *(1)*	`TxDataK[1..0]`
`rx_dataout[15..0]` *(1)*	`RxData[15..0]`
`rx_ctrldetect[1..0]` *(1)*	`RxDataK[1..0]`
`tx_detectrxloop`	`TxDetectRx/Loopback`
`tx_forceelecidle`	`TxElecIdle`
`tx_forcedispcompliance`	`TxCompliance`
`pipe8b10binvpolarity`	`RxPolarity`
`powerdn[1..0]` *(2)*	`PowerDown[1..0]`
`pipedatavalid`	`RxValid`
`pipephydonestatus`	`PhyStatus`
`pipeelecidle`	`RxElecIdle`
`pipestatus`	`RxStatus[2..0]`

Notes to Table 1–15:

(1) When used with PCIe hard IP block, the byte SERDES is not used. In this case, the data ports are 8 bits wide and control identifier is 1 bit wide.

(2) Cyclone IV GX transceivers do not implement power saving measures in lower power states (P0s, P1, and P2), except when putting the transmitter buffer in electrical idle in the lower power states.

Receiver Detection Circuitry

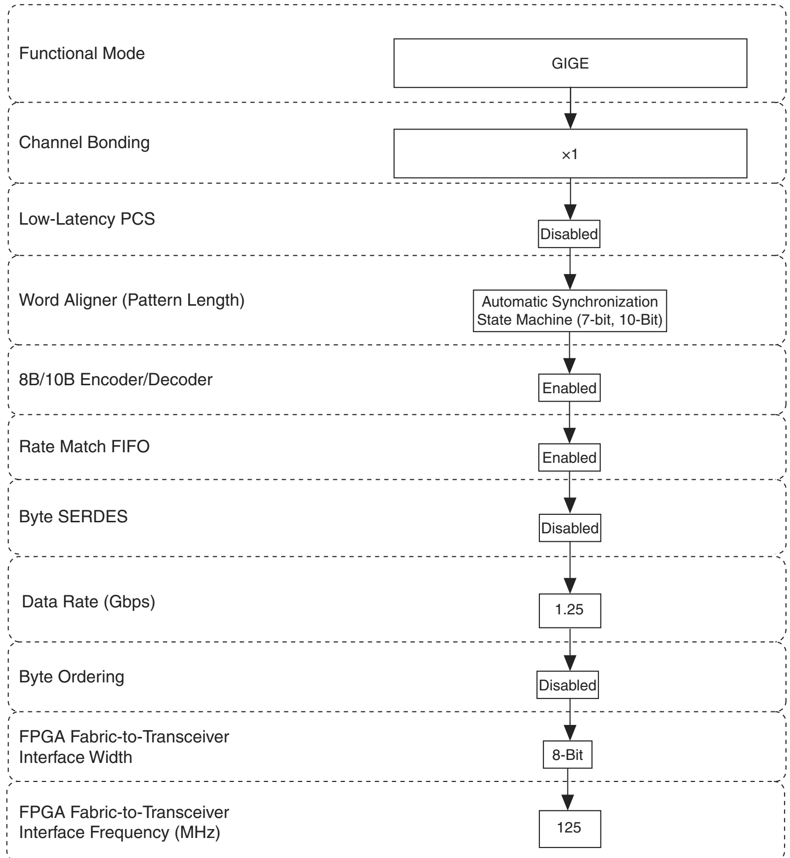
In PIPE mode, the transmitter supports receiver detection function with a built-in circuitry in the transmitter PMA. The PCIe protocol requires the transmitter to detect if a receiver is present at the far end of each lane as part of the link training and synchronization state machine sequence. This feature requires the following conditions:

- transmitter output buffer to be tri-stated
- have OCT utilization
- 125 MHz clock on the `fixedclk` port

The circuit works by sending a pulse on the common mode of the transmitter. If an active PCIe receiver is present at the far end, the time constant of the step voltage on the trace is higher compared to when the receiver is not present. The circuitry monitors the time constant of the step signal seen on the trace to decide if a receiver was detected.

Figure 1–56 shows the transceiver configuration in GIGE mode.

Figure 1–56. Transceiver Configuration in GIGE Mode



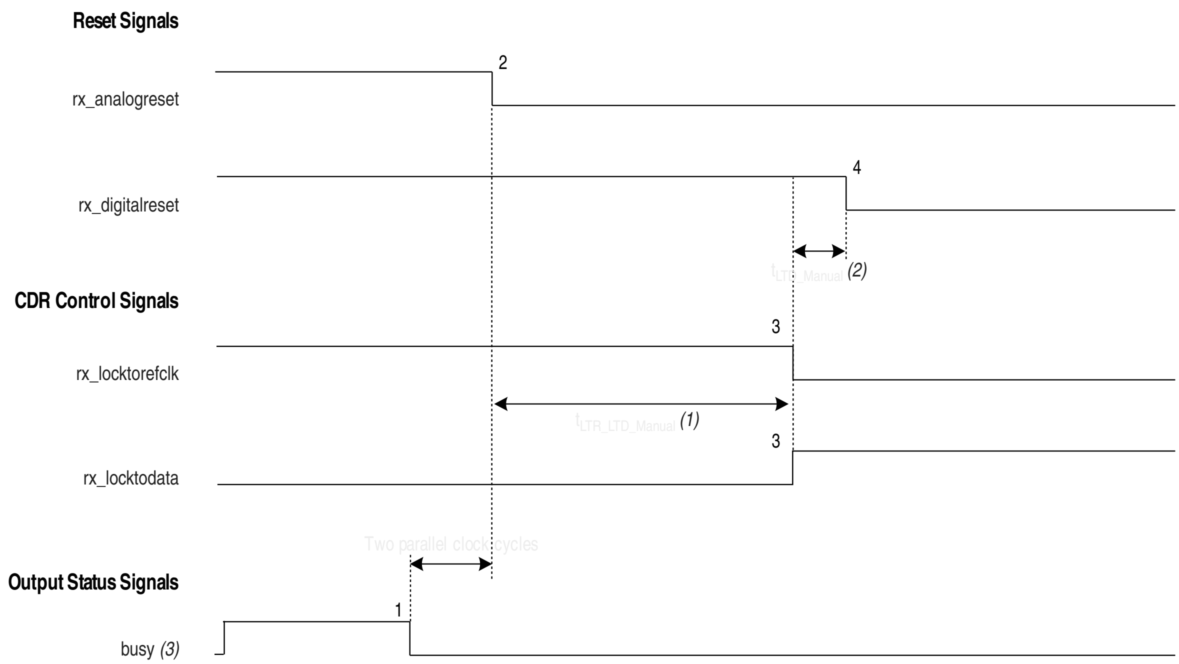
When configured in GIGE mode, three encoded comma (/K28.5/) code groups are transmitted automatically after deassertion of `tx_digitalreset` and before transmitting user data on the `tx_datain` port. This could affect the synchronization state machine behavior at the receiver.

Depending on when you start transmitting the synchronization sequence, there could be an even or odd number of encoded data (/Dx.y/) code groups transmitted between the last of the three automatically sent /K28.5/ code groups and the first /K28.5/ code group of the synchronization sequence. If there is an even number of /Dx.y/ code groups received between these two /K28.5/ code groups, the first /K28.5/ code group of the synchronization sequence begins at an odd code group boundary. An IEEE802.3-compliant GIGE synchronization state machine treats this as an error condition and goes into the Loss-of-Sync state.

Receiver Only Channel—Receiver CDR in Manual Lock Mode

This configuration contains only a receiver channel. If you create a **Receiver Only** instance in the ALTGX MegaWizard Plug-In Manager with receiver CDR in manual lock mode, use the reset sequence shown in Figure 2–7.

Figure 2–7. Sample Reset Sequence of Receiver Only Channel—Receiver CDR in Manual Lock Mode



Notes to Figure 2–7:

(1) For $t_{LTR\_LTD\_Manual}$ duration, refer to the *Cyclone IV Device Datasheet* chapter.

(2) For t_{LTD_Manual} duration, refer to the *Cyclone IV Device Datasheet* chapter.

(3) The `busy` signal is asserted and deasserted only during initial power up when offset cancellation occurs. In subsequent reset sequences, the `busy` signal is asserted and deasserted only if there is a read or write operation to the ALTGX_RECONFIG megafunction.

As shown in Figure 2–7, perform the following reset procedure for the receiver CDR in manual lock mode:

1. After power up, wait for the `busy` signal to be asserted.
2. Keep the `rx_digitalreset` and `rx_locktorefclk` signals asserted and the `rx_locktodata` signal deasserted during this time period.
3. After deassertion of the `busy` signal (marker 1), wait for two parallel clock cycles to deassert the `rx_analogreset` signal (marker 2). After `rx_analogreset` deassert, `rx_pll_locked` will assert.
4. Wait for at least $t_{LTR\_LTD\_Manual}$, then deassert the `rx_locktorefclk` signal. At the same time, assert the `rx_locktodata` signal (marker 3).
5. Deassert `rx_digitalreset at least` t_{LTD_Manual} `(the time between markers 3 and 4) after asserting the rx_locktodata signal. At this point, the receiver is ready to receive data.`

As shown in Figure 2–12, perform the following reset procedure when using the dynamic reconfiguration controller to change the configuration of the transceiver channel:

1. After power up and establishing that the transceiver is operating as desired, write the desired new value in the appropriate registers (including `reconfig_mode_sel[2:0]`) and subsequently assert the `write_all` signal (marker 1) to initiate the dynamic reconfiguration.

   For more information, refer to the *Cyclone IV Dynamic Reconfiguration* chapter.

2. Assert the `tx_digitalreset`, `rx_analogreset`, and `rx_digitalreset` signals.
3. As soon as `write_all` is asserted, the dynamic reconfiguration controller starts to execute its operation. This is indicated by the assertion of the `busy` signal (marker 2).
4. Wait for the assertion of the `channel_reconfig_done` signal (marker 4) that indicates the completion of dynamic reconfiguration in this mode.
5. Deassert the `tx_digitalreset signal` (marker 5). This signal must be deasserted after assertion of the `channel_reconfig_done` signal (marker 4) and before the deassertion of the `rx_analogreset` signal (marker 6).
6. Wait for at least five parallel clock cycles after assertion of the `channel_reconfig_done` signal (marker 4) to deassert the `rx_analogreset` signal (marker 6).
7. Lastly, wait for the `rx_freqlocked` signal to go high. After `rx_freqlocked` goes high (marker 7), wait for t_{LTD_Auto} to deassert the `rx_digitalreset` signal (marker 8). At this point, the receiver is ready for data traffic.

Power Down

The Quartus II software automatically selects the power-down channel feature, which takes effect when you configure the Cyclone IV GX device. All unused transceiver channels and blocks are powered down to reduce overall power consumption. The `gxb_powerdown` signal is an optional transceiver block signal. It powers down all transceiver channels and all functional blocks in the transceiver block. The minimum pulse width for this signal is 1 µs. After power up, if you use the `gxb_powerdown` signal, wait for deassertion of the `busy` signal, then assert the `gxb_powerdown` signal for a minimum of 1 µs. Lastly, follow the sequence shown in Figure 2–13.

Table 3–2. Dynamic Reconfiguration Controller Port List (ALTGX_RECONFIG Instance) (Part 4 of 7)

Port Name	Input/ Output	Description
Analog Settings Control/Status Signals		
`tx_vodctrl[2..0]` *(1)*	Input	This is an optional transmit buffer V_{OD} control signal. It is 3 bits per transmitter channel. The number of settings varies based on the transmit buffer supply setting and the termination resistor setting on the **TX Analog** screen of the ALTGX MegaWizard Plug-In Manager. The width of this signal is fixed to 3 bits if you enable either the **Use 'logical_channel_address' port for Analog controls reconfiguration** option or the **Use same control signal for all the channels** option in the **Analog controls** screen. Otherwise, the width of this signal is 3 bits per channel. The following shows the V_{OD} values corresponding to the `tx_vodctrl` settings for 100-Ω termination. For more information, refer to the "Programmable Output Differential Voltage" section of the *Cyclone IV GX Device Datasheet* chapter. `tx_vodctrl[2:0]` — Corresponding ALTGX instance settings — Corresponding V_{OD} settings (mV) 3'b001 — 1 — 400 3'b010 — 2 — 600 3'b011 — 3 — 800 3'b111 — 4 *(2)* — 900 *(2)* 3'b100 — 5 — 1000 3'b101 — 6 — *1200* All other values => N/A

Table 3–2. Dynamic Reconfiguration Controller Port List (ALTGX_RECONFIG Instance) (Part 5 of 7)

Port Name	Input/ Output	Description
`tx_preemp[4..0]` (1)	Input	This is an optional pre-emphasis write control for the transmit buffer. Depending on what value you set at this input, the controller dynamically writes the value to the pre-emphasis control register of the transmit buffer. The width of this signal is fixed to 5 bits if you enable either the **Use 'logical_channel_address' port for Analog controls reconfiguration** option or the **Use same control signal for all the channels** option in the **Analog controls** screen. Otherwise, the width of this signal is 5 bits per channel. `tx_preemp[4..0]` — Corresponding ALTGX instance settings — Corresponding pre-emphasis setting (mA) 00000 — 0 — Disabled 00001 — 1 — 0.5 00101 — 5 — 1.0 01001 — 9 — 1.5 01101 — 13 — 2.0 10000 — 16 — 2.375 10001 — 17 — 2.5 10010 — 18 — 2.625 10011 — 19 — 2.75 10100 — 20 — 2.875 10101 — 21 — 3.0 All other values => N/A
`rx_eqctrl[3..0]` (1)	Input	This is an optional write control to write an equalization control value for the receive side of the PMA. The width of this signal is fixed to 4 bits if you enable either the **Use 'logical_channel_address' port for Analog controls reconfiguration** option or the **Use same control signal for all the channels** option in the **Analog controls** screen. Otherwise, the width of this signal is 4 bits per channel. `rx_eqctrl[3..0]` — Corresponding ALTGX instance settings 0001 — Low 0101 — Medium Low 0100 — Medium High 0111 — High All other values => N/A

For more information about the supported maximum clock rate, device and pin planning, IP implementation, and device termination, refer to *Section III: System Performance Specifications* of the *External Memory Interfaces Handbook*.

Actual achievable frequency depends on design- and system-specific factors. Perform HSPICE/IBIS simulations based on your specific design and system setup to determine the maximum achievable frequency in your system.

High-Speed I/O Specifications

Table 1–31 through Table 1–36 list the high-speed I/O timing for Cyclone IV devices. For definitions of high-speed timing specifications, refer to “Glossary” on page 1–37.

Table 1–31. RSDS Transmitter Timing Specifications for Cyclone IV Devices (1), (2), (4) (Part 1 of 2)

Symbol	Modes	C6			C7, I7			C8, A7			C8L, I8L			C9L			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
f_{HSCLK} (input clock frequency)	×10	5	—	180	5	—	155.5	5	—	155.5	5	—	155.5	5	—	132.5	MHz
	×8	5	—	180	5	—	155.5	5	—	155.5	5	—	155.5	5	—	132.5	MHz
	×7	5	—	180	5	—	155.5	5	—	155.5	5	—	155.5	5	—	132.5	MHz
	×4	5	—	180	5	—	155.5	5	—	155.5	5	—	155.5	5	—	132.5	MHz
	×2	5	—	180	5	—	155.5	5	—	155.5	5	—	155.5	5	—	132.5	MHz
	×1	5	—	360	5	—	311	5	—	311	5	—	311	5	—	265	MHz
Device operation in Mbps	×10	100	—	360	100	—	311	100	—	311	100	—	311	100	—	265	Mbps
	×8	80	—	360	80	—	311	80	—	311	80	—	311	80	—	265	Mbps
	×7	70	—	360	70	—	311	70	—	311	70	—	311	70	—	265	Mbps
	×4	40	—	360	40	—	311	40	—	311	40	—	311	40	—	265	Mbps
	×2	20	—	360	20	—	311	20	—	311	20	—	311	20	—	265	Mbps
	×1	10	—	360	10	—	311	10	—	311	10	—	311	10	—	265	Mbps
t_{DUTY}	—	45	—	55	45	—	55	45	—	55	45	—	55	45	—	55	%
Transmitter channel-to-channel skew (TCCS)	—	—	—	200	—	—	200	—	—	200	—	—	200	—	—	200	ps
Output jitter (peak to peak)	—	—	—	500	—	—	500	—	—	550	—	—	600	—	—	700	ps
t_{RISE}	20 – 80%, C_{LOAD} = 5 pF	—	500	—	—	500	—	—	500	—	—	500	—	—	500	—	ps
t_{FALL}	20 – 80%, C_{LOAD} = 5 pF	—	500	—	—	500	—	—	500	—	—	500	—	—	500	—	ps